Octal buffer/line driver; 3-state Rev. 8 — 26 June 2013

Product data sheet

General description 1.

The 74LVC244A; 74LVCH244A is an octal non-inverting buffer/line driver with 3-state outputs. The 3-state outputs are controlled by the output enable inputs 1OE and 2OE. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state. Schmitt-trigger action at all inputs makes the circuit highly tolerant for slower input rise and fall times.

Inputs can be driven from either 3.3 V or 5.0 V devices. In 3-state operation, outputs can handle 5 V. These features allow the use of these devices as translators in a mixed 3.3 V and 5 V environment.

The 74LVCH244A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

Features and benefits 2.

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Inputs accept voltages up to 5.5 V
- High-impedance when V_{CC} = 0 V
- Bus hold on all data inputs (74LVCH244A only)
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

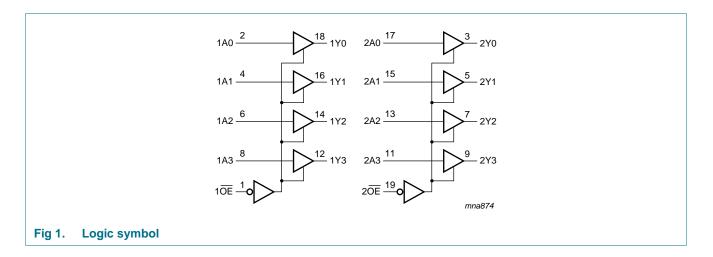


Octal buffer/line driver; 3-state

3. Ordering information

Table 1. Orderi	ng information						
Type number	Package						
	Temperature range	Name	Description	Version			
74LVC244AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1			
74LVCH244AD			body width 7.5 mm				
74LVC244ADB	-40 °C to +125 °C SSOP20 plastic shrink small outline package; 20 leads		plastic shrink small outline package; 20 leads;	SOT339-1			
74LVCH244ADB			body width 5.3 mm				
74LVC244APW	-40 °C to +125 °C TSSOP20		plastic thin shrink small outline package; 20 leads;	SOT360-1			
74LVCH244APW		body width 4.4 mm					
74LVC244ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced	SOT764-1			
74LVCH244ABQ			very thin quad flat package; no leads; 20 terminals; body 2.5 \times 4.5 \times 0.85 mm				
74LVC244ABX	–40 °C to +125 °C	DHXQFN20	plastic dual in-line compatible thermal enhanced	SOT1045-2			
74LVCH244ABX			extremely thin quad flat package; no leads; 20 terminals; body $4.5 \times 2.5 \times 0.5$ mm				

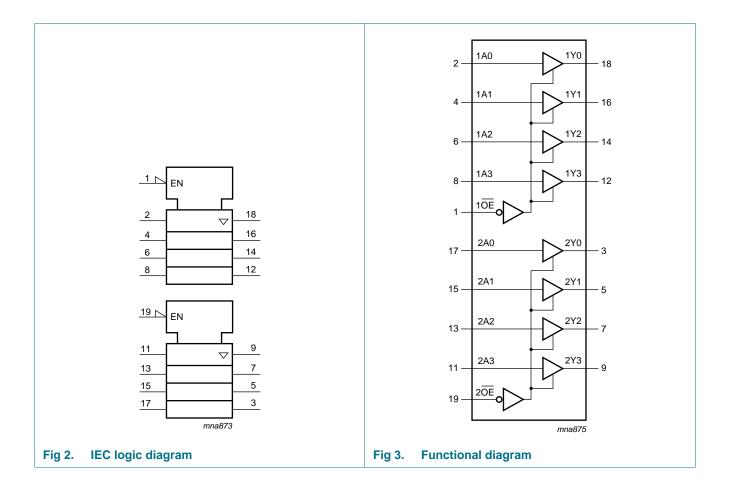
4. Functional diagram



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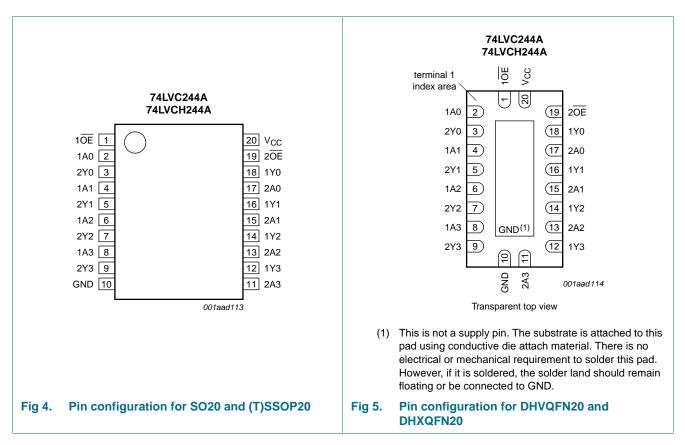
74LVC244A; 74LVCH244A

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5. Pinning information



5.2 Pin description

Table 2. Pin descri	ption	
Symbol	Pin	Description
10E, 20E	1, 19	output enable input (active low)
1A0, 1A1, 1A2, 1A3	2, 4, 6, 8	data input
2Y0, 2Y1, 2Y2, 2Y3	3, 5, 7, 9	data output
GND	10	ground (0 V)
2A0, 2A1, 2A2, 2A3	17, 15, 13, 11	data input
1Y0, 1Y1, 1Y2, 1Y3,	18, 16, 14, 12	data output
V _{CC}	20	supply voltage

5.1 Pinning

6. Functional description

Table 3. Function table [1]		
Control	Input	Output
nOE	nAn	nYn
L	L	L
L	Н	Н
Н	Х	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0$ V	-	±50	mA
Vo	output voltage	output HIGH or LOW	[2] -0.5	$V_{CC} + 0.5$	V
		output 3-state	[2] -0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	[3] _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

For SO20 packages: above 70 °C derate linearly with 8 mW/K.
 For (T)SSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN20 and DHXQFN20 packages: above 60 °C derate linearly with 4.5 mW/K.

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8. Recommended operating conditions

Table 5.	Recommended operating conditi	ons				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.2 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	–40 °C te	Unit	
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
V _{OH} HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	$I_{O} = -100 \ \mu\text{A};$ $V_{CC} = 1.65 \ \text{V} \text{ to } 3.6 \ \text{V}$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8$ mA; $V_{CC} = 2.3$ V	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		I_{O} = 8 mA; V_{CC} = 2.3 V	-	-	0.6	-	0.8	V
		I_{O} = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		I_{O} = 24 mA; V_{CC} = 3.0 V	-	-	0.55	-	0.8	V

74LVC_LVCH244A

Product data sheet

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Symbol	Parameter	Conditions		-40) °C to +85	S°C	–40 °C to	o +125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
lı	input leakage current	V _I = 5.5 V or GND; V _{CC} = 3.6 V	[2]	-	±0.1	±5	-	±20	μΑ
loz	OFF-state output current		[2]	-	±0.1	±5	-	±20	μA
I _{OFF}	power-off leakage current	$V_{\rm I}$ or $V_{\rm O}$ = 5.5 V; $V_{\rm CC}$ = 0.0 V		-	±0.1	±10	-	±20	μA
l _{cc}	supply current			-	0.1	10	-	40	μA
∆l _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$		-	5	500	-	5000	μA
CI	input capacitance			-	4.0	-	-	-	pF
BHL	bus hold	V_{CC} = 1.65 V; V_{I} = 0.58 V	<u>[3][4]</u>	10	-	-	10	-	μA
	LOW current	V_{CC} = 2.3 V; $V_{\rm I}$ = 0.7 V		30	-	-	25	-	μA
		$V_{CC} = 3.0 \text{ V}; \text{ V}_{I} = 0.8 \text{ V}$		75	-	-	60	-	μA
внн	bus hold	V_{CC} = 1.65 V; V_{I} = 1.07 V	[3][4]	-10	-	-	-10	-	μA
	HIGH current	$V_{CC} = 2.3 \text{ V}; \text{ V}_{I} = 1.7 \text{ V}$		-30	-	-	-25	-	μA
	ourient	$V_{CC} = 3.0 \text{ V}; \text{ V}_{I} = 2.0 \text{ V}$		-75	-	-	-60	-	μΑ
BHLO	bus hold	V _{CC} = 1.95 V	[3][5]	200	-	-	200	-	μA
	LOW overdrive	$V_{CC} = 2.7 V$		300	-	-	300	-	μA
	current	$V_{CC} = 3.6 V$		500	-	-	500	-	μΑ
внно	bus hold	V _{CC} = 1.95 V	<u>[3][5]</u>	-200	-	-	-200	-	μA
	HIGH	V _{CC} = 2.7 V		-300	-	-	-300	-	μA
	overdrive current	V _{CC} = 3.6 V		-500	-	-	-500	-	μΑ

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

[2] The bus hold circuit is switched off when $V_I > V_{CC}$ allowing 5.5 V on the input terminal.

[3] Valid for data inputs of bus hold parts only (74LVCH244A). Note that control inputs do not have a bus hold circuit.

[4] The specified sustaining current at the data input holds the input below the specified V_I level.

[5] The specified overdrive current at the data input forces the data input to the opposite input state.

Octal buffer/line driver; 3-state

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions			°C to +8	5 °C	-40 °C t	Unit	
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation	nAn to nYn; see <u>Figure 6</u>	[2]						
	delay	V _{CC} = 1.2 V		-	17.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	6.4	13.7	1.5	15.8	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	3.4	7.1	1.0	8.2	ns
		$V_{CC} = 2.7 V$		1.5	3.4	6.9	1.5	9.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	2.9	5.9	1.5	7.5	ns
t _{en}	enable time	n <mark>OE</mark> to nYn; see <u>Figure 7</u>	[2]						
		V _{CC} = 1.2 V		-	24.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	7.0	17.3	1.5	20.0	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.9	9.5	1.5	11.0	ns
		$V_{CC} = 2.7 V$		1.5	4.1	8.6	1.5	11.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	3.2	7.6	1.0	9.5	ns
t _{dis}	disable time	n <mark>OE</mark> to nYn; see <u>Figure 7</u>	[2]						
		$V_{CC} = 1.2 V$		-	9.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.2	4.5	9.8	2.2	11.3	ns
		V_{CC} = 2.3 V to 2.7 V		0.5	3.6	5.5	0.5	6.4	ns
		$V_{CC} = 2.7 V$		1.5	3.3	6.8	1.5	8.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	3.1	5.8	1.5	7.5	ns
t _{sk(o)}	output skew time		<u>[3]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power	per input; $V_I = GND$ to V_{CC}	<u>[4]</u>						
	dissipation capacitance	V_{CC} = 1.65 V to 1.95 V		-	6.4	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	9.6	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	12.5	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} . t_{en} is the same as t_{PZL} and t_{PZH} .

 t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 $f_i = \text{input}$ frequency in MHz; $f_o = \text{output}$ frequency in MHz

 C_L = output load capacitance in pF

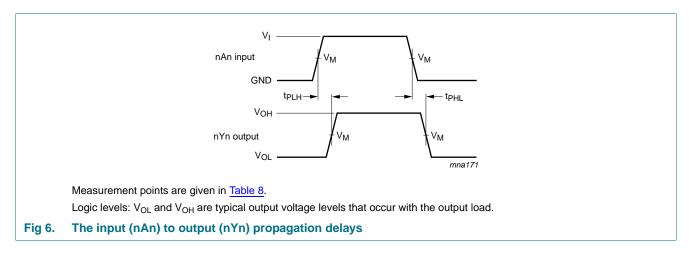
V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

Octal buffer/line driver; 3-state

11. AC waveforms



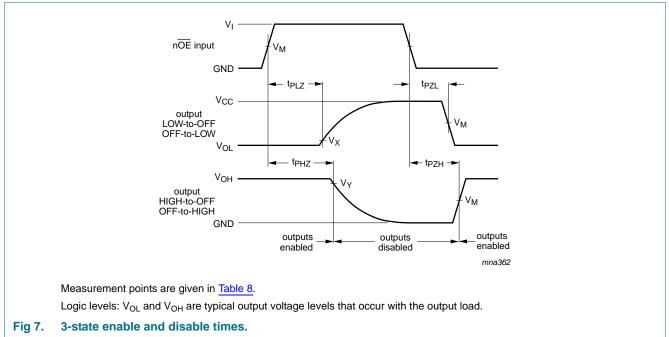


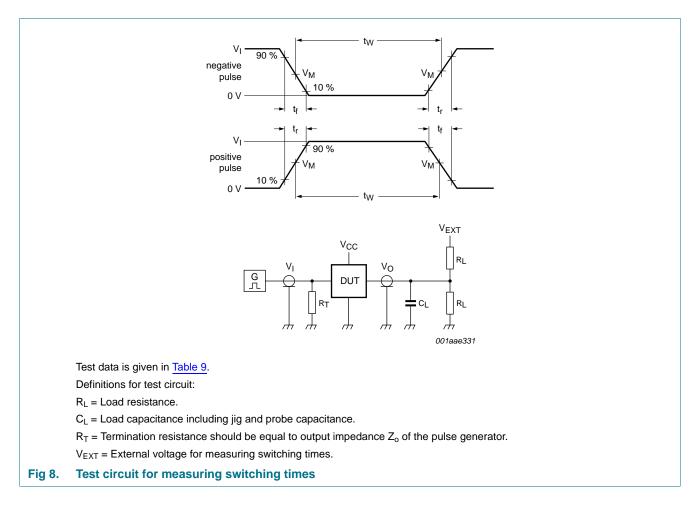
Table 8.Measurement points

Supply voltage	Input		Output	Output		
V _{CC}	VI	V _M	V _M	V _X	V _Y	
1.2 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$	
1.65 V to 1.95 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V	
2.3 V to 2.7 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V	
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V	
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	$V_{OH} - 0.3 \ V$	

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74LVC244A; 74LVCH244A

Octal buffer/line driver; 3-state



	Tab	le 9.	Test	data
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Supply voltage	Input	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

Octal buffer/line driver; 3-state

12. Package outline

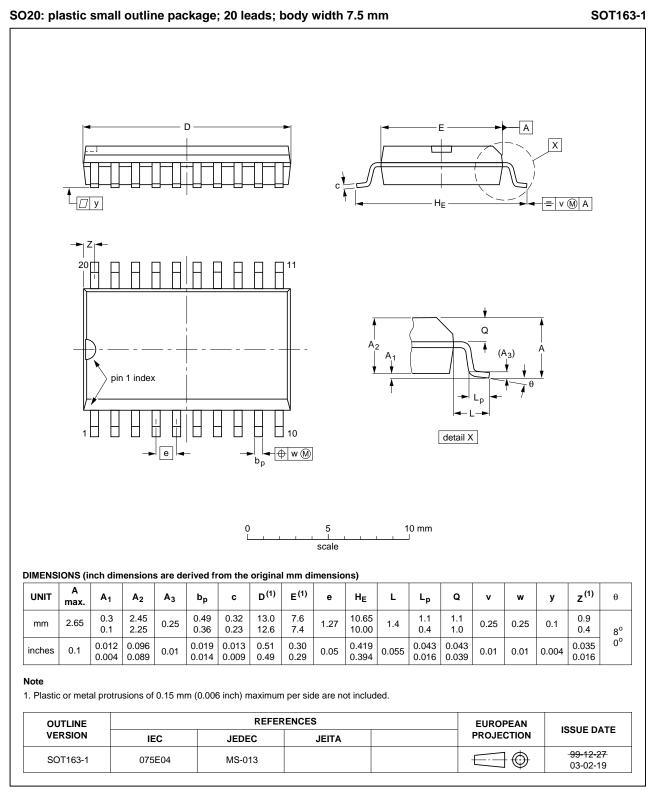


Fig 9. Package outline SOT163-1 (SO20)

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Octal buffer/line driver; 3-state

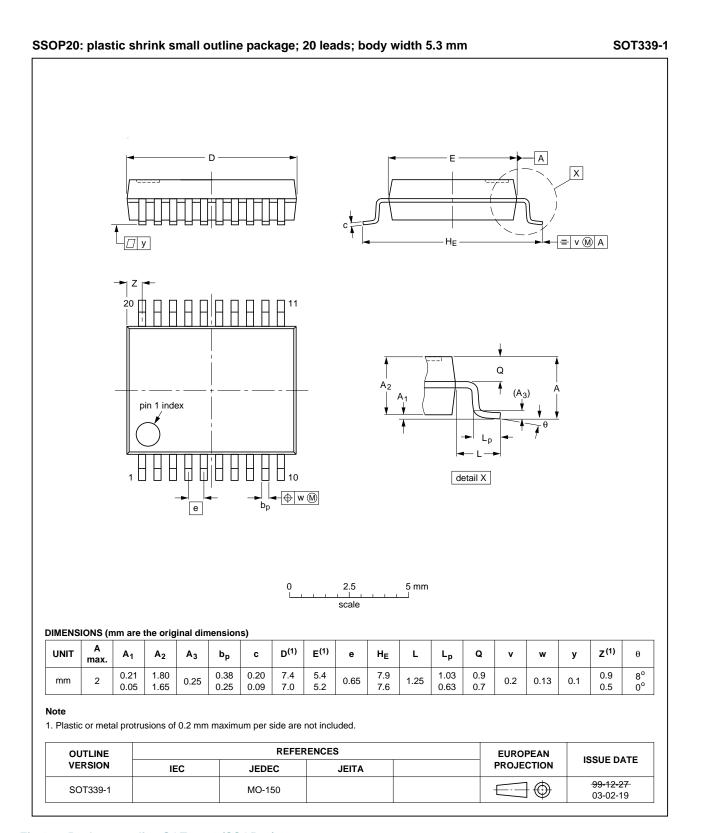


Fig 10. Package outline SOT339-1 (SSOP20)

Octal buffer/line driver; 3-state

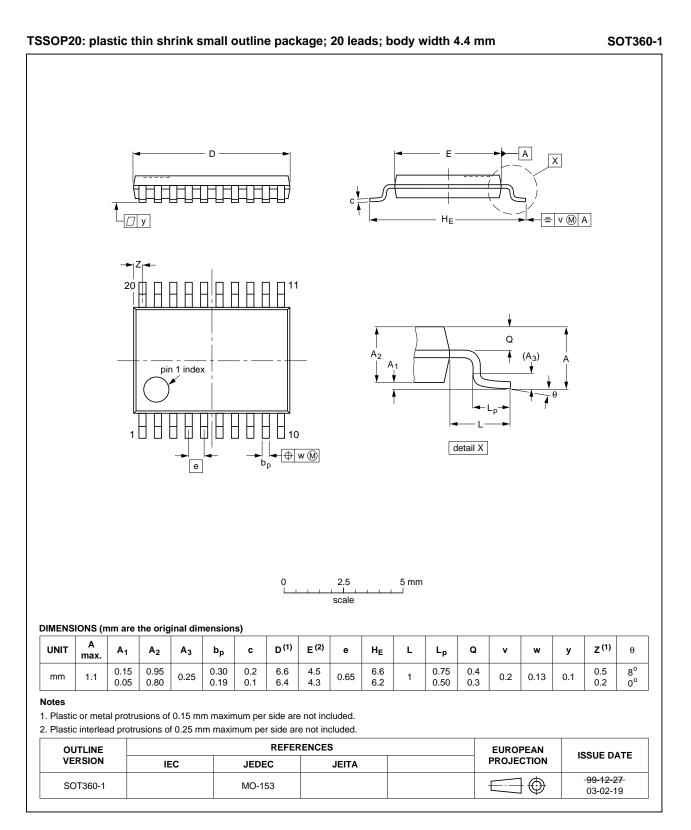
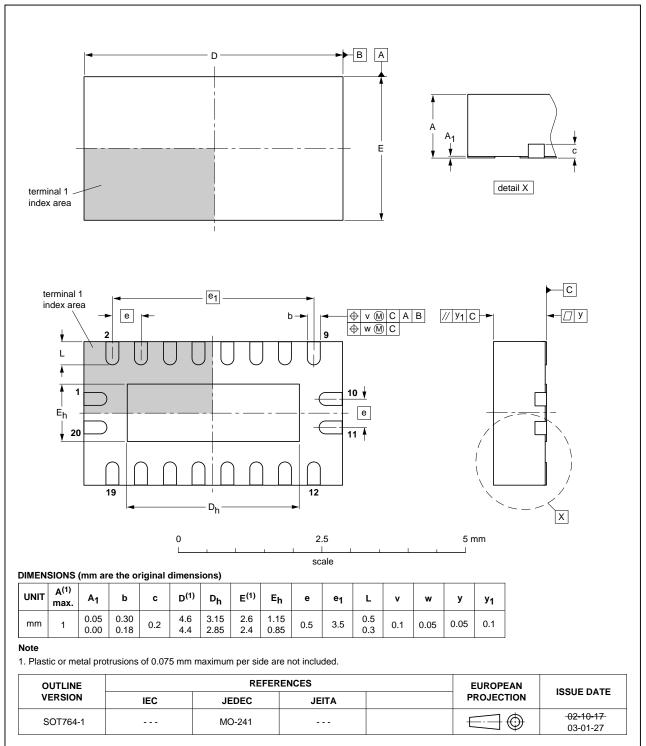


Fig 11. Package outline SOT360-1 (TSSOP20)

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Octal buffer/line driver; 3-state

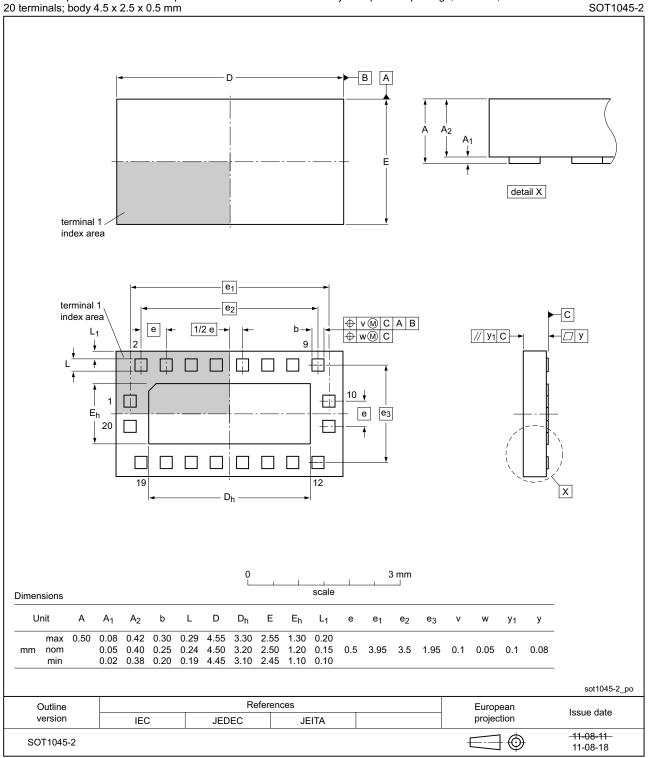


DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 12. Package outline SOT764-1 (DHVQFN20)

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Octal buffer/line driver; 3-state



DHXQFN20: plastic dual in-line compatible thermal enhanced extremely thin quad flat package; no leads;

Fig 13. Package outline SOT1045-2 (DHXQFN20)

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Octal buffer/line driver; 3-state

13. Abbreviations

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11.Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH244A v.8	20130626	Product data sheet	-	74LVC_LVCH244A v.7
Modifications:	21	numbers 74LVC244ABX ged to DHXQFN20 (SOT		BX DHXQFN20U (SOT1045-1)
74LVC_LVCH244A v.7	20111122	Product data sheet	-	74LVC_LVCH244A v.6
Modifications:		at of this document has b s of NXP Semiconductors	•	comply with the new identity
	 Legal text 	s have been adapted to	the new company	name where appropriate.
	• <u>Table 4</u> , <u>T</u> ranges.	able 5, <u>Table 6</u> , <u>Table 7</u> ,	Table 8 and Table	9: values added for lower voltage
74LVC_LVCH244A v.6	20090813	Product data sheet	-	74LVC_LVCH244A v.5
74LVC_LVCH244A v.5	20090709	Product data sheet	-	74LVC_LVCH244A v.4
74LVC_LVCH244A v.4	20031030	Product specification	-	74LVC_LVCH244A v.3
74LVC_LVCH244A v.3	20030520	Product specification	-	74LVC_H244A v.2
74LVC_H244A v.2	19980520	Product specification	-	74LVC244A_74LVCH244A v.1
74LVC244A_74LVCH244A v.1	19960906	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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